



**10NM50**

Preliminary

**Power MOSFET**

**10A, 500V N-CHANNEL  
SUPER-JUNCTION MOSFET**

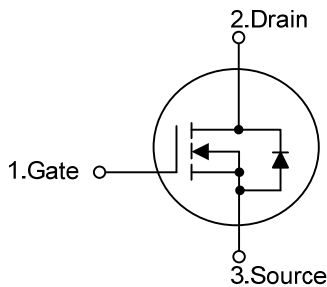
■ DESCRIPTION

The **UTC 10NM50** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- \*  $R_{DS(ON)} < 0.35\Omega @ V_{GS}=10V, I_D=5.0A$
- \* By using Super Junction Structure
- \* Fast Switching
- \* With 100% Avalanche Tested

■ SYMBOL

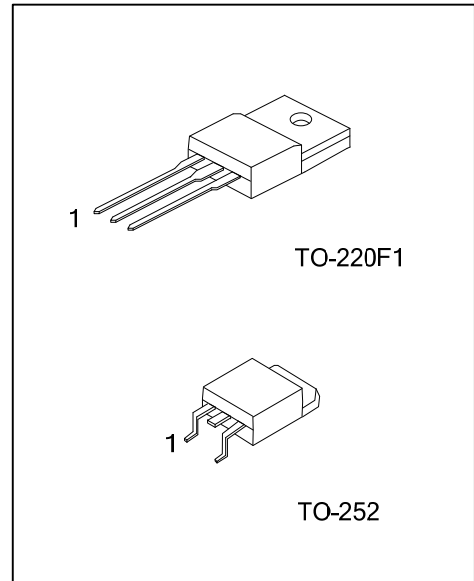


■ ORDERING INFORMATION

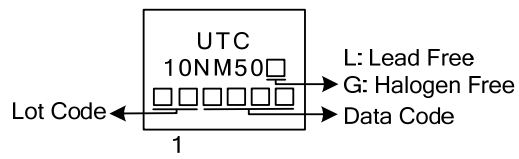
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
10NM50L-TF1-T	10NM50G-TF1-T	TO-220F1	G	D	S	Tube
10NM50L-TN3-R	10NM50G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>10NM50L-TF1-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TF1: TO-220F1, TN3: TO-252</p> <p>(3) L: Lead Free, G: Halogen Free and Lead Free</p>
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### MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	10	A
	Pulsed (Note 2)	$I_{DM}$	40	A
Avalanche Current (Note 2)		$I_{AR}$	5.3	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	140	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6.5	V/ns
Power Dissipation	TO-220F1	$P_D$	48	W
	TO-252		108	W
Junction Temperature		$T_J$	150	$^\circ\text{C}$
Storage Temperature Range		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3.  $L=10\text{mH}$ ,  $I_{AS}=5.3\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$

4.  $I_{SD}\leq 10\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220F1	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-252		110	
Junction to Case	TO-220F1	$\theta_{JC}$	2.6	$^\circ\text{C}/\text{W}$
	TO-252		1.16	

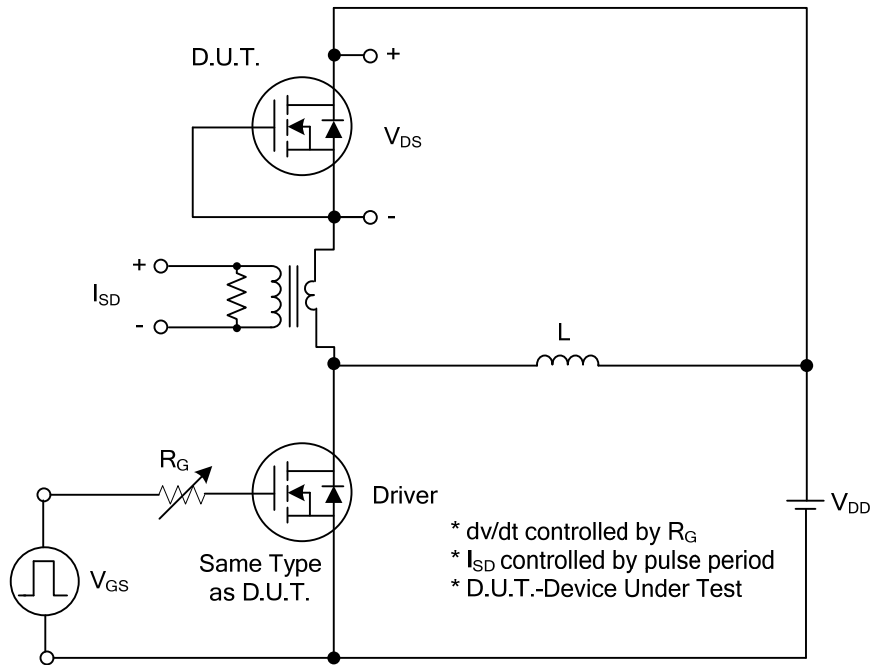
■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	500			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=500V, V_{GS}=0V$			10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 30V$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5		4.5	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5.0A$			0.35	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{ISS}$	$V_{GS}=0V, V_{DS}=25V, f=1.0\text{MHz}$		620		pF
Output Capacitance	$C_{OSS}$			480		pF
Reverse Transfer Capacitance	$C_{RSS}$			56		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge (Note 1)	$Q_G$	$V_{DS}=50V, V_{GS}=10V, I_D=1.3A, I_G=100\mu A$ (Note 1, 2)		42		nC
Gate to Source Charge	$Q_{GS}$			4		nC
Gate to Drain Charge	$Q_{GD}$			17.5		nC
Turn-ON Delay Time (Note 1)	$t_{D(ON)}$	$V_{DD}=30V, V_{GS}=10V, I_D=0.5A, R_G=25\Omega$ (Note 1, 2)		60		ns
Rise Time	$t_R$			103		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			152		ns
Fall-Time	$t_F$			112		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				10	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				40	A
Drain-Source Diode Forward Voltage (Note 1)	$V_{SD}$	$I_S=10A, V_{GS}=0V$			1.4	V
Body Diode Reverse Recovery Time (Note 1)	$t_{rr}$	$I_S=10A, V_{GS}=0V, dI_F/dt=100A/\mu s$		310		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			3.8		$\mu C$

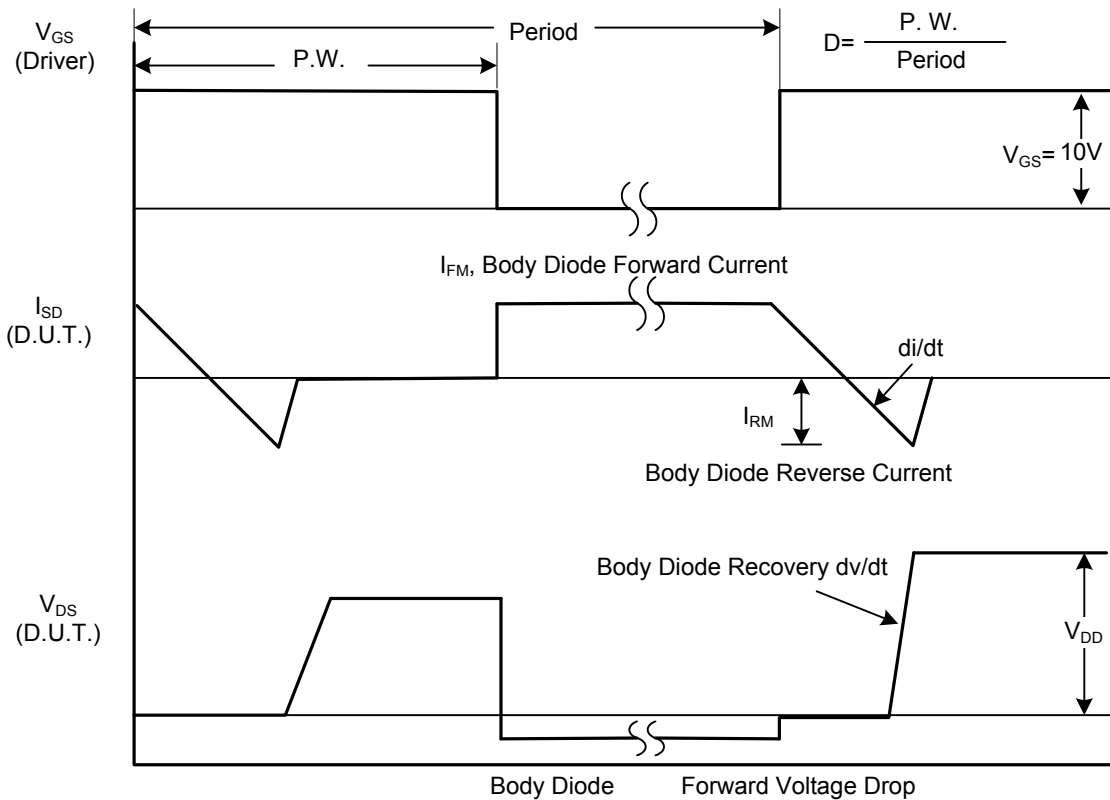
Notes: 1. Pulse Test : Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

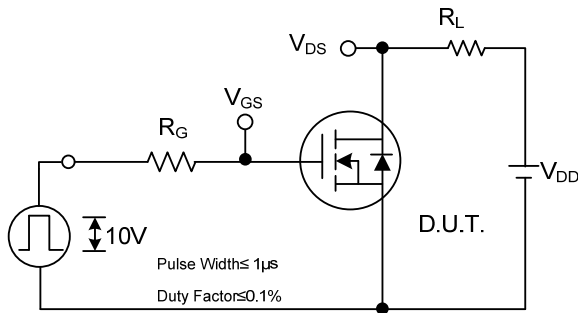


Peak Diode Recovery dv/dt Test Circuit

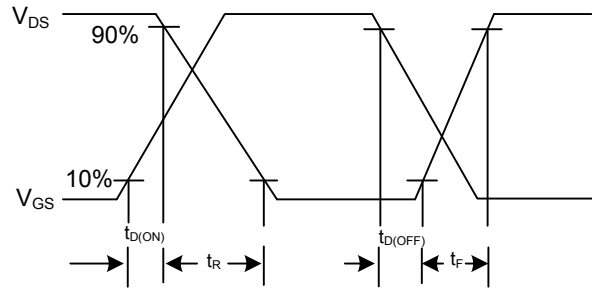


Peak Diode Recovery dv/dt Waveforms

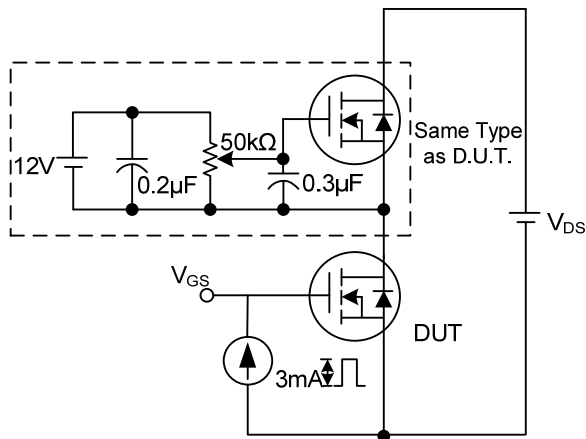
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



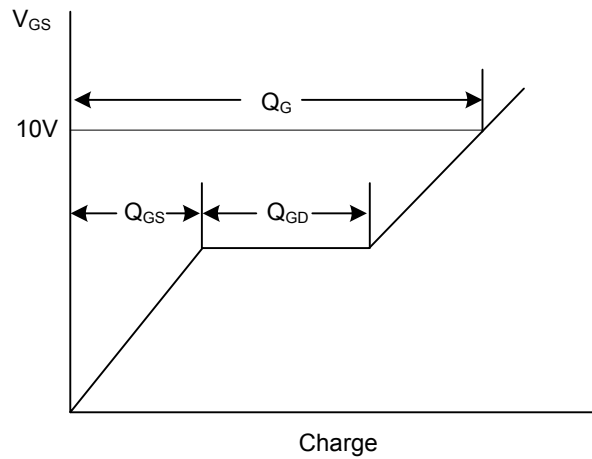
Switching Test Circuit



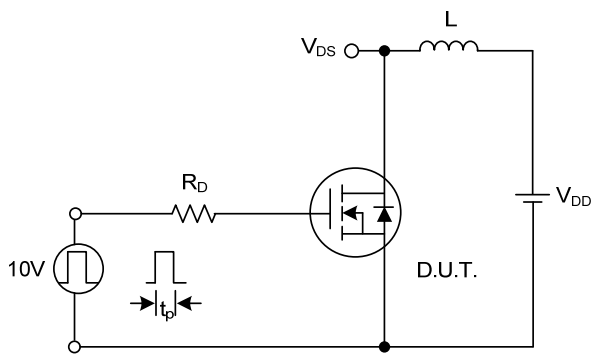
Switching Waveforms



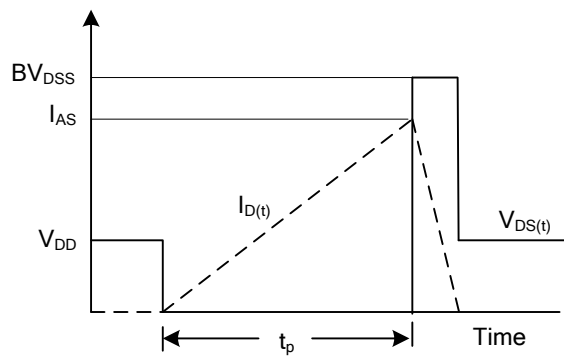
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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